

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	200	Vdc
Drain-Gate Voltage ($R_{GS} = 1.0 \text{ m}\Omega$)	V_{DGR}	200	Vdc
Gate-Source Voltage	V_{GS}	± 20	Vdc
Drain Current Continuous	I_D	3.5	Adc
Pulsed	I_{DM}	14	
Total Power Dissipation @ $T_C = 25^\circ\text{C}$ Derate above 25°C	P_D	20 0.16	Watts W/ $^\circ\text{C}$
Operating and Storage Temperature Range	T_J, T_{stg}	-55 to 150	$^\circ\text{C}$

THERMAL CHARACTERISTICS

Thermal Resistance Junction to Case	$R_{\theta JC}$	6.25	$^\circ\text{C/W}$
Thermal Resistance Junction to Ambient	$R_{\theta JA}$	175	$^\circ\text{C/W}$
Maximum Lead Temperature 1.6 mm from Case for 10 s	T_L	300	$^\circ\text{C}$

ELECTRICAL CHARACTERISTICS ($T_C = 25^\circ\text{C}$ unless otherwise noted.)

Characteristic	Symbol	Min	Max	Unit
----------------	--------	-----	-----	------

OFF CHARACTERISTICS

Drain-Source Breakdown Voltage ($V_{GS} = 0, I_D = 0.25 \text{ mA}$)	$V_{(BR)DSS}$	200	—	Vdc
Zero Gate Voltage Drain Current ($V_{DS} = \text{Rated } V_{DSS}, V_{GS} = 0$) ($V_{DS} = 0.8 \text{ Rated } V_{DSS}, V_{GS} = 0, T_J = 125^\circ\text{C}$)	I_{DSS}	—	250 1000	μAdc
Gate-Body Leakage Current, Forward ($V_{GS} = 20 \text{ Vdc}, V_{DS} = 0$)	I_{GSSF}	—	100	nAdc
Gate-Body Leakage Current, Reverse ($V_{GS} = -20 \text{ Vdc}, V_{DS} = 0$)	I_{GSSR}	—	-100	nAdc

ON CHARACTERISTICS*

Gate Threshold Voltage ($V_{DS} = V_{GS}, I_D = 1.0 \text{ mA}$)	$V_{GS(th)}$	2.0	4.0	Vdc
Static Drain-Source On-Resistance ($V_{GS} = 10 \text{ Vdc}, I_D = 2.25 \text{ Adc}$) $T_A = 25^\circ\text{C}$ $T_A = 125^\circ\text{C}$	$r_{DS(on)}$	—	0.8 1.5	Ohm
Drain-Source On-Voltage ($V_{GS} = 10 \text{ V}, I_D = 3.5 \text{ Adc}$)	$V_{DS(on)}$	—	2.8	Vdc
Forward Transconductance ($V_{DS} = 5.0 \text{ V}, I_D = 2.25 \text{ Adc}$)	g_{fs}	1.5	4.5	mhos

DYNAMIC CHARACTERISTICS

Input Capacitance	$(V_{DS} = 25 \text{ V}, V_{GS} = 0, f = 1.0 \text{ MHz})$	C_{iss}	200	600	pF
Output Capacitance		C_{oss}	60	300	
Reverse Transfer Capacitance		C_{rss}	15	80	

SWITCHING CHARACTERISTICS*

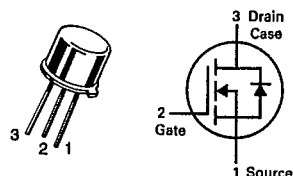
Turn-On Delay Time	$(V_{DD} = 74 \text{ V}, I_D = 2.25 \text{ A}, R_{gen} = 50 \text{ ohms})$	$t_{d(on)}$	—	40	ns
Rise Time		t_r	—	50	
Turn-Off Delay Time		$t_{d(off)}$	—	50	
Fall Time		t_f	—	50	

SOURCE-DRAIN DIODE CHARACTERISTICS*

Forward Diode Voltage	$(I_S = \text{Rated } I_{D(on)}, V_{GS} = 0)$	V_{SD}	0.7	1.5	Vdc
Forward Turn-On Time		t_{on}	—	Negligible	ns
Reverse Recovery Time		t_{rr}	—	350	ns

*Pulse Test: Pulse Width $\leq 300 \mu\text{s}$, Duty Cycle $\leq 2.0\%$.

2N6790

CASE 79-05, STYLE 6
TO-39 (TO-205AF)MOS FET
TRANSISTOR
N-CHANNEL — ENHANCEMENT